

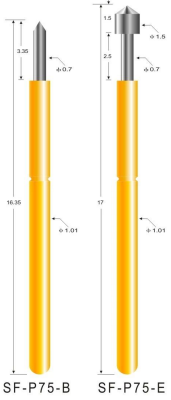
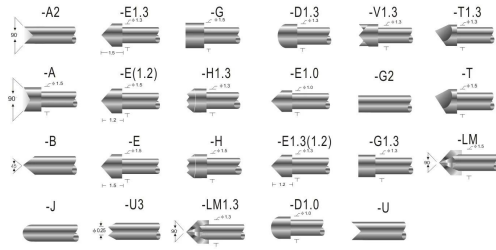
PCB test spring loaded contact probe

Product information

Brand	SFENG
Item number	PCB test spring loaded contact probe
Series	SF-PA75, SF-PA11 and SF-PA111
Plunger	Be Cu, gold/Nickel plated
Body	Brass, gold plated
Spring	stainless steel
Spring force	120g, 150g, and 120g
Current ration	3A



SF-P75



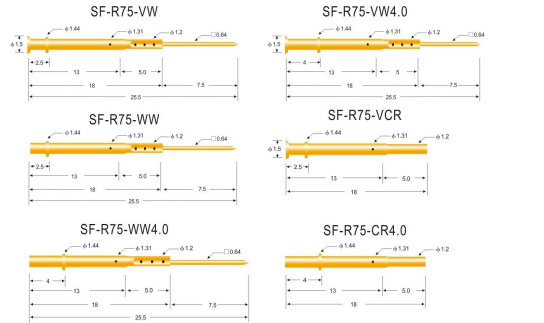
Probe specifications SF-P75(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 3.35(.1319")/2.50(.0984")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Phosphor bronze, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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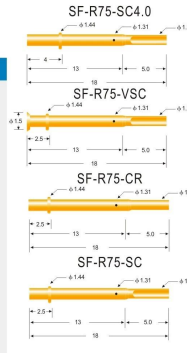
Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

SF-R75



Probe specifications SF-R75(技术规格)

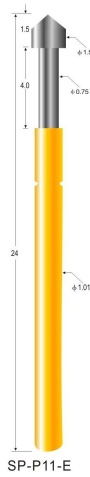
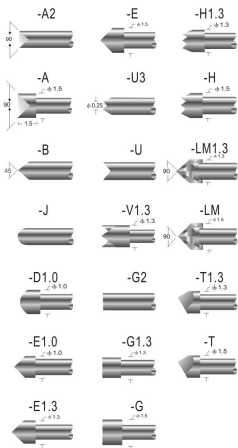
- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R75-VCR, R75-CR, R75-CR4.0 Solder cup: R75-VSC, R75-SC, R75-SC4.0 Wire wrap: R75-VW, R75-WW, R75-VW4.0, R75-WW4.0



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SF-P11



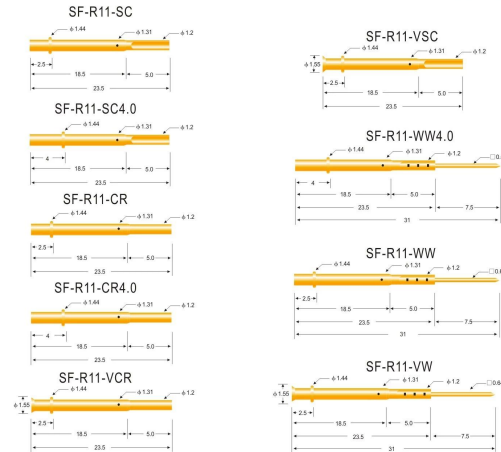
Probe specifications SF-P11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 4.0(.1575")
- Spring force(弹簧压力): 150g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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SF-R11



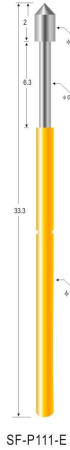
Probe specifications SF-R11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R11-VCR, R11-CR, R11-CR4.0 Solder cup: R11-VSC, R11-SC, R11-SC4.0 Wire wrap: R11-VW, R11-WW, R11-WW4.0

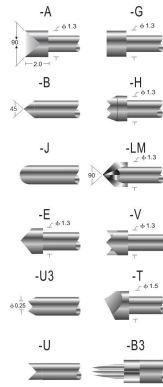
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SF-P111



SF-P111-E

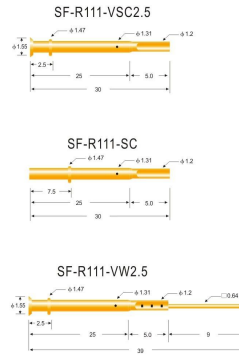
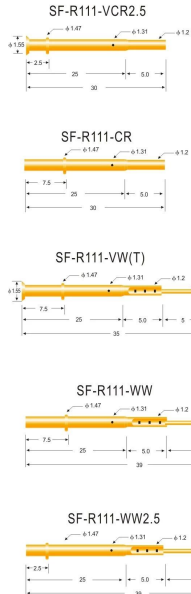


Probe specifications SF-P111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 6.3(.2481")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰):
Plunger: Be, Cu, Rh plated
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)

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SF-R111



Probe specifications SF-R111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰):
Barrel: Brass, Gold plated
- Connections(接线形式):
Crimp: R111-VCR2.5, R111-CR
Solder cup: R111-VSC2.5, R111-SC
Wire wrap: R111-VW2.5, R111-WW2.5, R111-WW
Terminal: R111-VW(T)

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Production Flow



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products

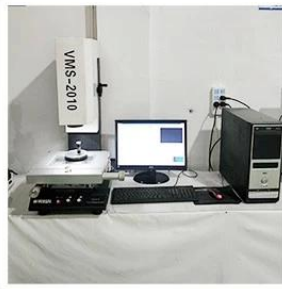


6. Packing

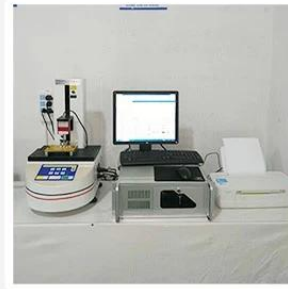
Test Equipment



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Packaging and Shipment

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

